



Aliases (C1808C391J5GAC7800)

SMD Comm COG, Ceramic, 390 pF, 5%, 50 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1808



Click here for the 3D model.

Dimensions	
Chip Size	1808
L	4.7mm +/-0.5mm
W	2mm +/-0.2mm
Т	1mm +/-0.15mm
В	0.6mm +/-0.35mm

	Packaging Specifications	kaging Specifications	
	Packaging	T&R, 180mm, Plastic Tape	
	Packaging Quantity	2500	
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General Information			
Series	SMD Comm COG		
Style	SMD Chip		
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I		
Features	Ultra-Stable, Low Loss, Class I		
RoHS	Yes		
Termination	Tin		
Marking	No		
AEC-Q200	No		
Component Weight	62 mg		
Shelf Life	78 Weeks		
MSL	1		

Specifications			
Capacitance	390 pF		
Measurement Condition	1 MHz 1.0Vrms		
Capacitance Tolerance	5%		
Voltage DC	50 VDC		
Dielectric Withstanding Voltage	125 VDC		
Temperature Range	-55/+125°C		
Temperature Coefficient	COG		
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms		
Dissipation Factor	0.1% 1 MHz 1.0Vrms		
Aging Rate	0% Loss/Decade Hour		
Insulation Resistance	100 GOhms		

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